



Final Product Change Notification

202605016F01 : EMGS 625 & DFI ATKL Assy & FT Site Expansion as Dual Source

Note: This notice is NXP Company
Proprietary.

Issue Date: Jun 08, 2026 **Effective Date:** Sep 06, 2026

Dear Emma Tempest,

Here is your personalized communication about an NXP notification.
For detailed information we invite you to [view this notification online](#)

Management summary

NXP ATKL (Assembly and Test, Kuala Lumpur, Malaysia) is being added as a dual source for Assembly and Final Test for the EMGS625 rev D & DFI product.

Change Category

☐ Wafer Fab Process	☐ Assembly Process	☐ Product Marking	☐ Test Process	☐ Design
☐ Wafer Fab Materials	☒ Assembly Materials	☐ Mechanical Specification	☐ Test Equipment	☐ Errata
☐ Wafer Fab Location	☒ Assembly Location	☒ Packing/Shipping/Labeling	☒ Test Location	☐ Electrical spec./Test coverage
☐ Firmware	☐ Other			

Notification Overview

Description

NXP ATKL (Assembly and Test, Kuala Lumpur, Malaysia) is being added as a dual source for Assembly and Final Test for the EMGS625 & DFI product family.

Assembly:

NXP ATKL (Assembly and Test, Kuala Lumpur, Malaysia) has been qualified as 2nd source assembly package site for LQFP64.

Assembly site expansion was successfully qualified adhering to NXP specifications.

Corresponding ZVEI Delta Qualification Matrix ID: SEM-PA-08 and SEM-PA-18

See the attached self qualification report for details.

Final Test :

The same tester platform, HW, test program as used at the current site NXP ATTJ, Tianjin, China will be used at NXP ATKL, Kuala Lumpur, Malaysia.

Final test site transfer was successfully qualified adhering to NXP specifications.

Corresponding ZVEI Delta Qualification Matrix ID: SEM-TF-01

Packing:

Corresponding ZVEI Delta Qualification Matrix ID: SEM-PS-01

Current situation: Assembly in NXP-ATTJ, Final Test in NXP-ATTJ.

New situation: Assembly in NXP-ATTJ and NXP-ATKL, Final Test in NXP-ATTJ and NXP-ATKL.

Reason

Qualification of NXP ATKL Kuala Lumpur, Malaysia is required for manufacturing resilience and customer supply assurance.

Identification of Affected Products

Top Side Marking

The assembly site code is identified by the first character of the fourth line of the top side marking, CT=ATTJ. Q=ATKL. See the attached Product Qualification Package for marking details.

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment Oct 19, 2026

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

No impact to existing data sheet

Disposition of Old Products

Assembly and Final test site transfer. No Depletion of Inventory required

Customers may receive product from either NXP-ATTJ or NXP-ATKL manufacturing sites.

Additional information

Self qualification:[view online](#)

Additional documents: [view online](#)

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by Jul 08, 2026.

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Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Position PRODUCT MARKETING NON SIP

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NXP Quality Management Team.

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